Docket No.

296428US26PCT

DEC 1 8 2006

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## IN THE UNITED STATES PA

IN RE APPLICATION OF:

Tsuyoshi TAKAHASHI, et al.

SERIAL NO:

10/593,254

GAU:

1762

ADEMARK OFFICE

FILED:

September 18, 2006

EXAMINER:

FOR:

METHOD AND APPARATUS FOR FORMING METAL SILICATE FILM, AND METHOD FOR

MANUFACTURING SEMICONDUCTOR DEVICE

# **INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97**

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

#### REFERENCES

- The applicant(s) wish to make of record the references cited in the attached International Search Report and listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

## RELATED CASES

- Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

#### **CERTIFICATION**

- Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

### DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

Steven P. Weihrouch

Registration No. 32,829

Joseph Scafetta, Jr. Registration No. 26,803

Customer Number

22850

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03)

| LIST OF REFERENCES CITED BY APPLICANT  DEC 1 8 2006  U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE  LIST OF REFERENCES CITED BY APPLICANT  DEC 1 8 2006  U.S. PATENT DOCUMENTS  EXAMINER INITIAL  DOCUMENT NUMBER  AA 2006/0216953 A1 09/28/06 Shigeru NAKAJIMA, et al.  AB  AC  AD  ATTY DOCKET NO.  296428US26PCT  APPLICANT  Tsuyoshi TAKAHASHI, et al.  FILING DATE  SERIAL NO.  10/593,254  APPLICANT  Tsuyoshi TAKAHASHI, et al.  FILING DATE  NAME  CLASS SUB CLASS IF APPROPR  CLASS SUB CLASS IF APPROPR  SERIAL NO.  10/593,254  |        |  |
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| *Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.   |        |  |